

EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S1	11288	solder adj resist	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/26 16:28
S2	205293	saw or surface adj acoustic adj wave	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/26 16:33
S3	234	S1 and S2	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/26 16:28
S4	34502	metal adj frame	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/26 16:29
S5	14	S3 and S4	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/27 08:07
S6	21094	resist adj mask	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/26 16:33
S7	352	S2 and S6	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/26 16:33

EAST Search History

S8	0	S4 and S7	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/26 16:33
S9	209191	saw or surface adj acoustic adj wave or baw or balk adj acoustic adj wave	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/27 06:13
S10	825	S4 and S9	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/26 16:34
S11	0	S6 and S10	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/26 16:34
S12	357	S6 and S9	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/26 16:35
S13	0	S4 and S12	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/26 16:35
S14	16122	csp or chip adj size adj package	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/27 06:12

EAST Search History

S15	674184	moisture	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/27 06:12
S16	129113	hermetically	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/27 06:12
S17	103	S14 and S15 and S16	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/27 06:12
S18	209254	saw or surface adj acoustic adj wave or baw or balk adj acoustic adj wave	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/27 06:13
S19	48	S18 and S17	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/27 06:13
S20	7	("20040237299" "3615913" "4040874" "5300812" "5334874" "5987732" "6777767").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2007/03/27 06:23
S21	24883	flip adj chip	US-PGPUB; USPAT; USOCR	OR	ON	2007/03/27 06:23
S22	1631	S16 and S21	US-PGPUB; USPAT; USOCR	OR	ON	2007/03/27 06:23
S23	380	S18 and S22	US-PGPUB; USPAT; USOCR	OR	ON	2007/03/27 06:23
S24	20	("4864470").URPN.	USPAT	OR	ON	2007/03/27 06:26

EAST Search History

S25	495	(438/26).CCLS.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	OFF	2007/03/27 07:42
S26	1	(substrate and bond and terminal adj electrode and resist adj pattern and solder and barrier adj metal).clm.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/27 08:09
S27	1	(bond and resist adj pattern and solder and barrier adj metal).clm.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/27 08:13
S28	709	(257/684).CCLS.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	OFF	2007/03/27 08:14
S29	194	barrier adj metal and hermetically adj sealed	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/27 08:50
S30	2533	sealing adj frame	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/27 08:50
S31	4247	sealing adj frame or seal adj frame	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/27 08:51

EAST Search History

S32	2	S29 and S31	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/27 09:06
S33	3	257/e21.513	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/27 09:06